

PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| JOERG PALM | 11/05/2021 |
| THOMAS NIESEN | 11/08/2021 |
| ERIK TRABITZSCH | 10/28/2021 |
| RECEIVING PARTY DATA | |
| Name: | (CNBM) BENGBU DESIGN & RESEARCH INSTITUTE FOR GLASS INDUSTRY CO., LTD |
| Street Address: | NO. 1047 TUSHAN ROAD BENGBU, ANHUI |
| City: | BENGBU |
| State/Country: | CHINA |
| Postal Code: | 233010 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 17609423 |
| CORRESPONDENCE DATA | |
| Fax Number: | |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 7024625973 |
| Email: | in@bayramoglu-legal.com |
| Correspondent Name: | GOKALP BAYRAMOGLU |
| Address Line 1: | 1540 W.WARM SPRINGS ROAD SUITE: 100 HENDERSON |
| Address Line 2: | SUITE 100 |
| Address Line 4: | HENDERSON, NEVADA 89014 |
| ATTORNEY DOCKET NUMBER: | GBWK018 |
| NAME OF SUBMITTER: | GOKALP BAYRAMOGLU |
| SIGNATURE: | /GOKALP BAYRAMOGLU/ |
| DATE SIGNED: | 11/08/2021 |
| Total Attachments: 3 | |
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| source=2-GBWK018-Assignment-signed#page2.tif | |

ASSIGNMENT

(1-8) *Insert Name(s) of Inventor(s)*

(1) Joerg PALM

(2) Thomas NIESEN

For good and valuable consideration receipt of which is hereby acknowledged, the undersigned agree(s) to assign, and hereby do(es) assign, transfer and set over to:

| | |
|--|---|
| (9) <i>Insert name of Assignee</i> | (9) (CNBM) BENGBU DESIGN & RESEARCH INSTITUTE FOR GLASS INDUSTRY CO., LTD |
| (10) <i>Insert state of incorporation of Assignee</i> | (10) China |
| (11) <i>Insert address of Assignee</i> | (11) No. 1047 Tushan Road Bengbu, Anhui, China 233010 (hereinafter designated as the Assignee) the entire right, title, interest, and patent applications and patents within the United States, including divisions, reissues, continuations and all other extensions, rights and priorities in the invention known as and subject matter contained in |
| (12) <i>Insert Identification of Invention, such as Title, Case Number or Foreign Application Number</i> | (12) PROCESS AND DEVICE FOR PRODUCING A CHALCOGEN-CONTAINING COMPOUND SEMICONDUCTOR |
| (13) <i>Insert Date of Filing of Application</i> | (13) <u>Application is attached hereto.</u> |

1) The undersigned agree(s) to execute all papers necessary in connection with the application and any continuing or division applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

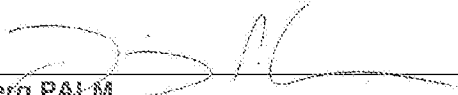
5) The undersigned hereby authorize(s) and request(s) the Commissioner for Patents and the duly constituted authorities of foreign countries to issue any and all Letters Patents resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, its successors and assigns, as Assignee of the entire right, title and interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

6) *The undersigned hereby grant(s)*

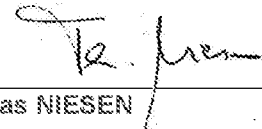
Gokalp Bayramoglu, Reg.No. 66305

the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date November 5, 2021


Joerg PALM

Date November 8, 2021


Thomas NIESEN

ASSIGNMENT

(1-8) *Insert Name(s) of Inventor(s)* (3) **Erik TRABITZSCH**

For good and valuable consideration receipt of which is hereby acknowledged, the undersigned agree(s) to assign, and hereby do(es) assign, transfer and set over to:

| | |
|--|--|
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| (10) <i>Insert state of incorporation of Assignee</i> | (10) China |
| (11) <i>Insert address of Assignee</i> | (11) No. 1047 Tushan Road Bengbu, Anhui, China 233010 (hereinafter designated as the Assignee) the entire right, title, interest, and patent applications and patents within the United States, including divisions, reissues, continuations and all other extensions, rights and priorities in the invention known as and subject matter contained in |
| (12) <i>Insert Identification of Invention, such as Title, Case Number or Foreign Application Number</i> | (12) PROCESS AND DEVICE FOR PRODUCING A CHALCOGEN-CONTAINING COMPOUND SEMICONDUCTOR |
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2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

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Gokalp Beyramoglu, Reg.No. 66305

the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date 2021. 10. 28

Erik TRABITZSCH